



ALPHA & OMEGA
SEMICONDUCTOR

AOT2904/AOB2904

100V N-Channel AlphaSGT™

General Description

- Trench Power AlphaSGT™ technology
- Low $R_{DS(ON)}$
- Low Gate Charge
- Optimized fast-switching applications

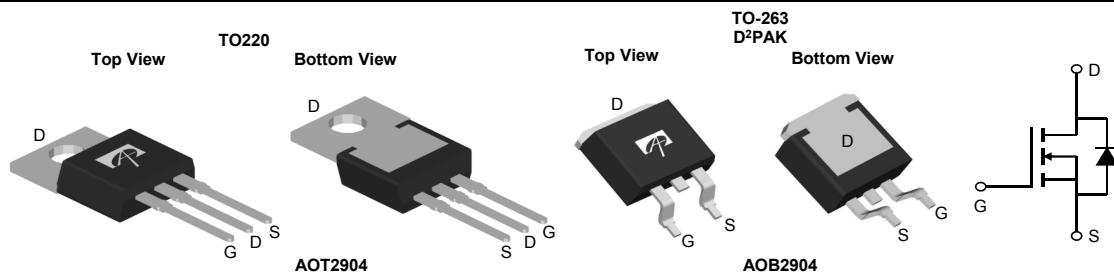
Product Summary

V_{DS}	100V
I_D (at $V_{GS}=10V$)	120A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 4.4mΩ < 4.2mΩ*
$R_{DS(ON)}$ (at $V_{GS}=6V$)	< 5.5mΩ < 5.2mΩ*

Applications

- Industrial
- BMS battery protection
- Synchronous Rectifiers in DC/DC and AC/DC Converters

100% UIS Tested
100% R_g Tested



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOT2904	TO-220	Tube	1000
AOB2904	TO-263	Tape & Reel	800

Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^G	I_D	120	A
$T_C=100^\circ C$		120	
Pulsed Drain Current ^C	I_{DM}	425	A
Continuous Drain Current	I_{DSM}	29	A
$T_A=70^\circ C$		23	
Avalanche Current ^C	I_{AS}	77	A
Avalanche energy $L=0.1\text{mH}$ ^C	E_{AS}	296	mJ
V_{DS} Spike ^I	V_{SPIKE}	120	V
Power Dissipation ^B	P_D	326	W
$T_C=100^\circ C$		163	
Power Dissipation ^A	P_{DSM}	8.3	W
$T_A=70^\circ C$		5.3	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 175	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{θJA}$	12	15	°C/W
Maximum Junction-to-Ambient ^{AB}		50	60	°C/W
Maximum Junction-to-Case	$R_{θJC}$	0.36	0.46	°C/W

* Surface mount package TO263(AOB2904)

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{ID}=250\mu\text{A}, \text{VGS}=0\text{V}$	100			V
I_{DSS}	Zero Gate Voltage Drain Current	$\text{V}_{\text{DS}}=100\text{V}, \text{V}_{\text{GS}}=0\text{V}$		1		μA
			$\text{T}_J=55^\circ\text{C}$		5	
I_{GSS}	Gate-Body leakage current	$\text{V}_{\text{DS}}=0\text{V}, \text{V}_{\text{GS}}=\pm 20\text{V}$			± 100	nA
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_{\text{D}}=250\mu\text{A}$	2.3	2.75	3.3	V
$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_{\text{D}}=20\text{A}$	TO-220	3.6	4.4	$\text{m}\Omega$
			$\text{T}_J=125^\circ\text{C}$	6.3	7.7	
		$\text{V}_{\text{GS}}=6\text{V}, \text{I}_{\text{D}}=20\text{A}$	TO-220	4.1	5.5	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=10\text{V}, \text{I}_{\text{D}}=20\text{A}$	TO-263	3.4	4.2	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=6\text{V}, \text{I}_{\text{D}}=20\text{A}$	TO-263	3.9	5.2	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$\text{V}_{\text{DS}}=5\text{V}, \text{I}_{\text{D}}=20\text{A}$		90		S
V_{SD}	Diode Forward Voltage	$\text{I}_{\text{S}}=1\text{A}, \text{V}_{\text{GS}}=0\text{V}$		0.68	1	V
I_{S}	Maximum Body-Diode Continuous Current ^G				120	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=50\text{V}, \text{f}=1\text{MHz}$		7085		pF
C_{oss}	Output Capacitance			605		pF
C_{rss}	Reverse Transfer Capacitance			32		pF
R_{g}	Gate resistance	$\text{f}=1\text{MHz}$	0.7	1.5	2.3	Ω
SWITCHING PARAMETERS						
$\text{Q}_{\text{g}}(10\text{V})$	Total Gate Charge	$\text{V}_{\text{GS}}=10\text{V}, \text{V}_{\text{DS}}=50\text{V}, \text{I}_{\text{D}}=20\text{A}$		93	135	nC
Q_{gs}	Gate Source Charge			23		nC
Q_{gd}	Gate Drain Charge			16		nC
$\text{t}_{\text{D(on)}}$	Turn-On DelayTime	$\text{V}_{\text{GS}}=10\text{V}, \text{V}_{\text{DS}}=50\text{V}, \text{R}_{\text{L}}=2.5\Omega, \text{R}_{\text{GEN}}=3\Omega$		21		ns
t_{r}	Turn-On Rise Time			22		ns
$\text{t}_{\text{D(off)}}$	Turn-Off DelayTime			58		ns
t_{f}	Turn-Off Fall Time			20		ns
t_{rr}	Body Diode Reverse Recovery Time	$\text{I}_{\text{F}}=20\text{A}, \text{di/dt}=500\text{A}/\mu\text{s}$		49		ns
Q_{rr}	Body Diode Reverse Recovery Charge	$\text{I}_{\text{F}}=20\text{A}, \text{di/dt}=500\text{A}/\mu\text{s}$		460		nC

A. The value of R_{BJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $\text{T}_A=25^\circ\text{C}$. The Power dissipation P_{DSM} is based on $\text{R}_{\text{BJA}} \leq 10\text{s}$ and the maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design, and the maximum temperature of 175°C may be used if the PCB allows it.

B. The power dissipation P_0 is based on $\text{T}_{\text{J(MAX)}}=175^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Single pulse width limited by junction temperature $\text{T}_{\text{J(MAX)}}=175^\circ\text{C}$.

D. The R_{BJA} is the sum of the thermal impedance from junction to case R_{BJC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

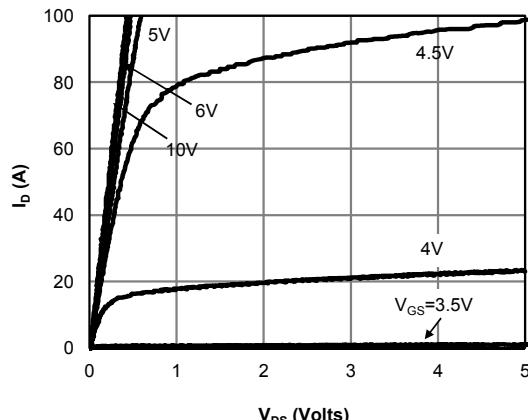
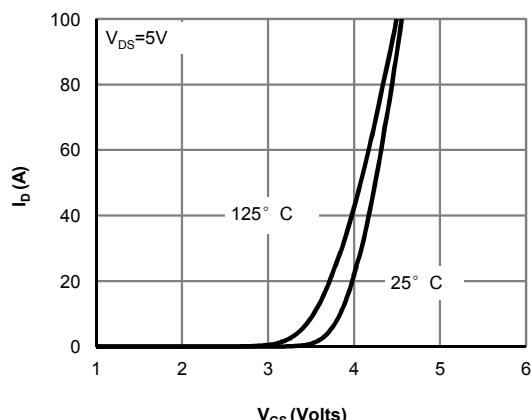
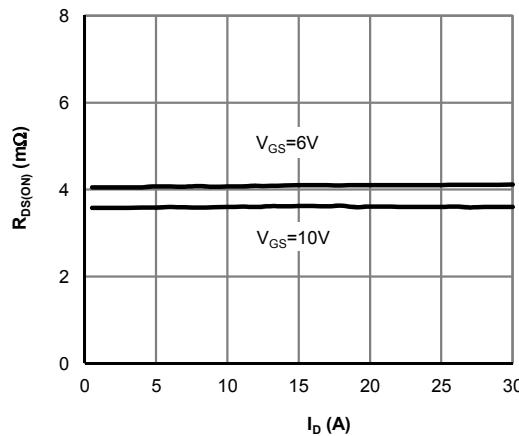
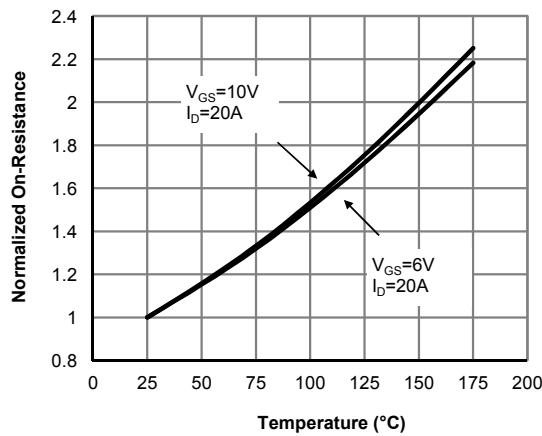
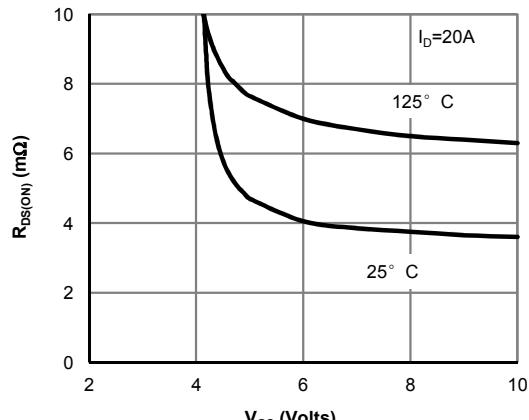
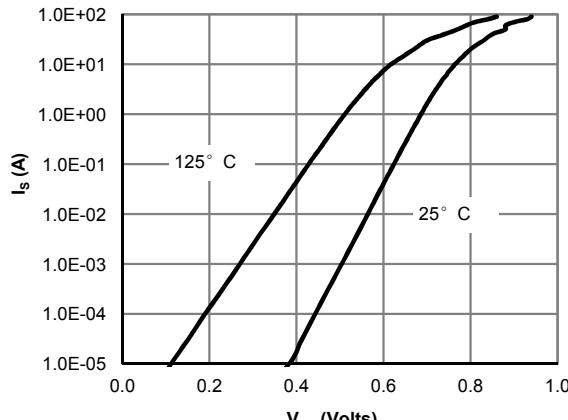
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $\text{T}_{\text{J(MAX)}}=175^\circ\text{C}$. The SOA curve provides a single pulse rating.

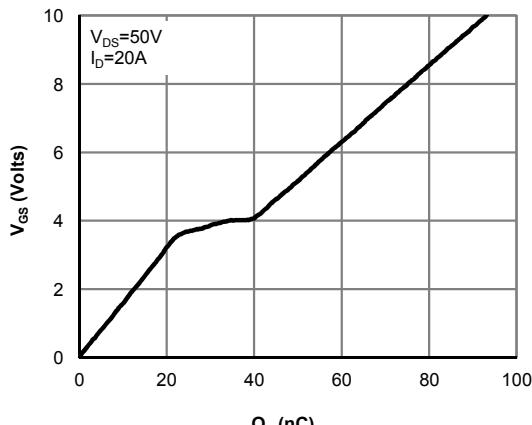
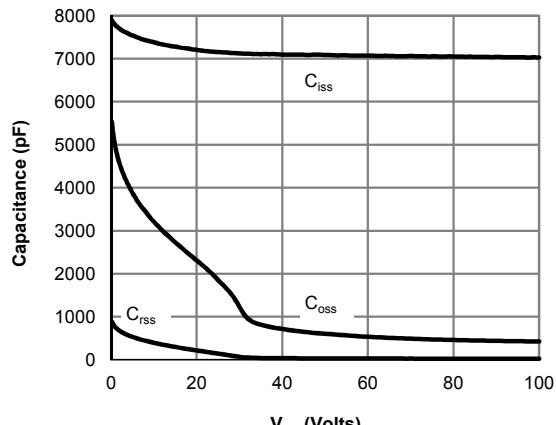
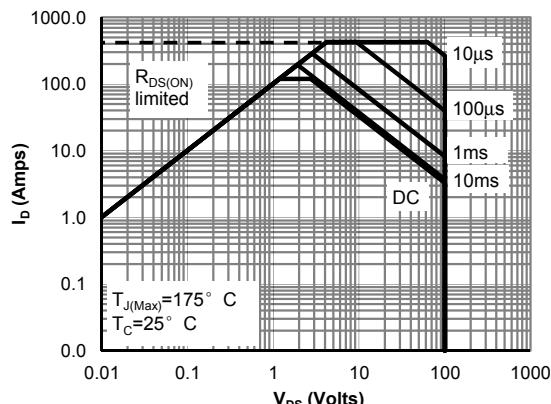
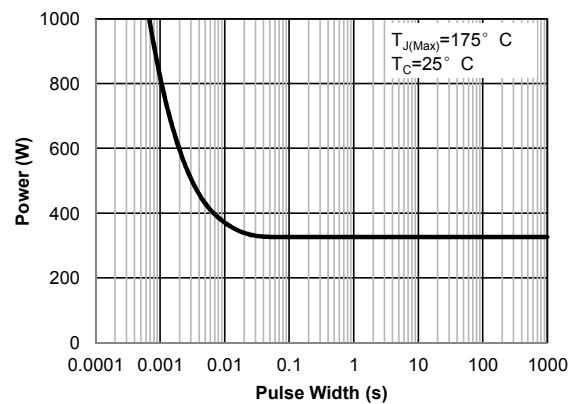
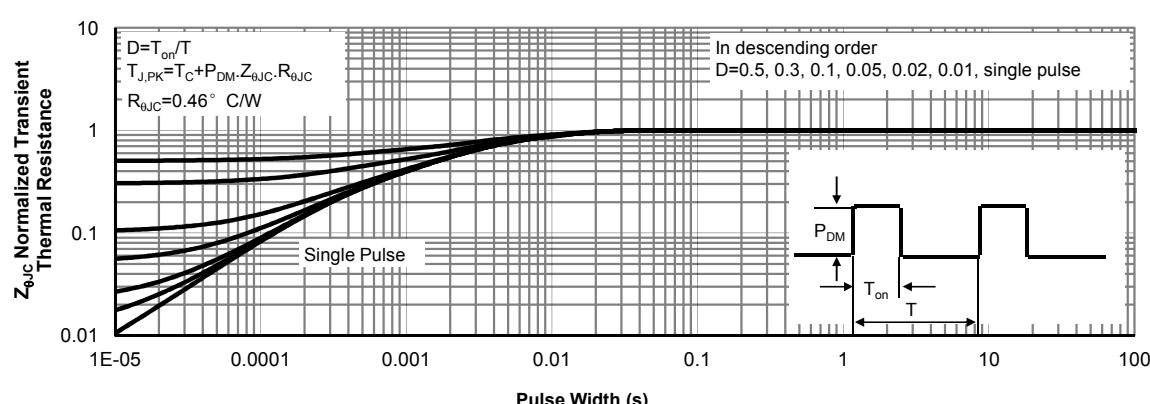
G. The maximum current rating is package limited.

H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $\text{T}_A=25^\circ\text{C}$.

I. The spike duty cycle 5% max, limited by junction temperature $\text{T}_{\text{J(MAX)}}=125^\circ\text{C}$.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 1: On-Region Characteristics (Note E)

Figure 2: Transfer Characteristics (Note E)

Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

Figure 4: On-Resistance vs. Junction Temperature (Note E)

Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics

Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

Figure 10: Single Pulse Power Rating Junction-to-Case (Note F)

Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

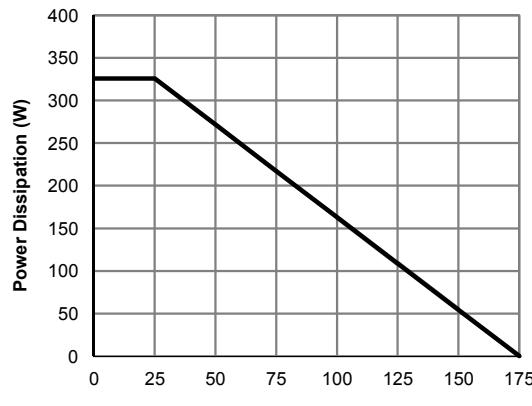
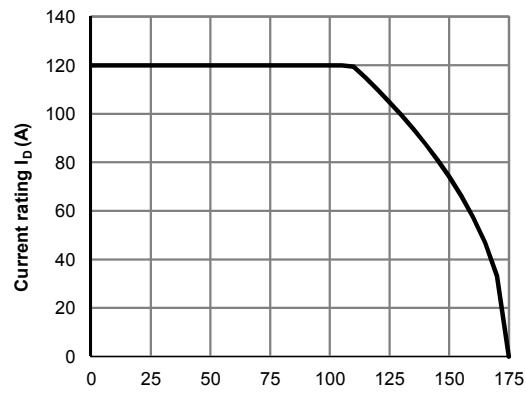
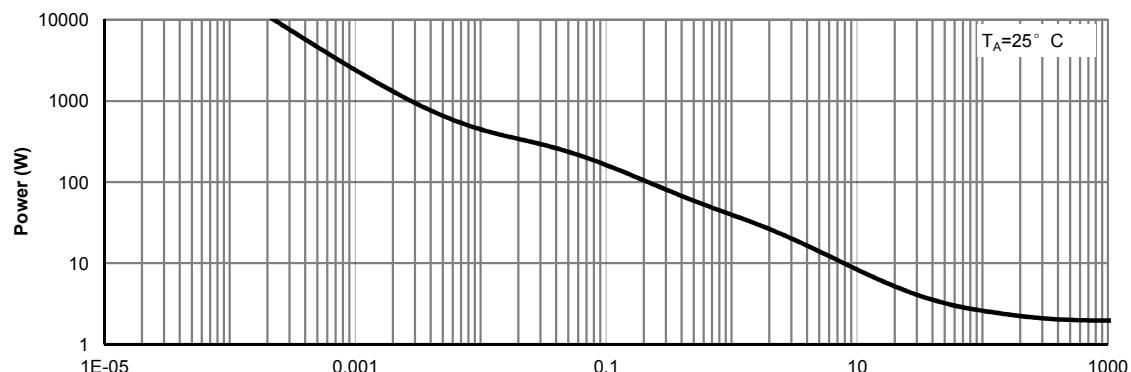
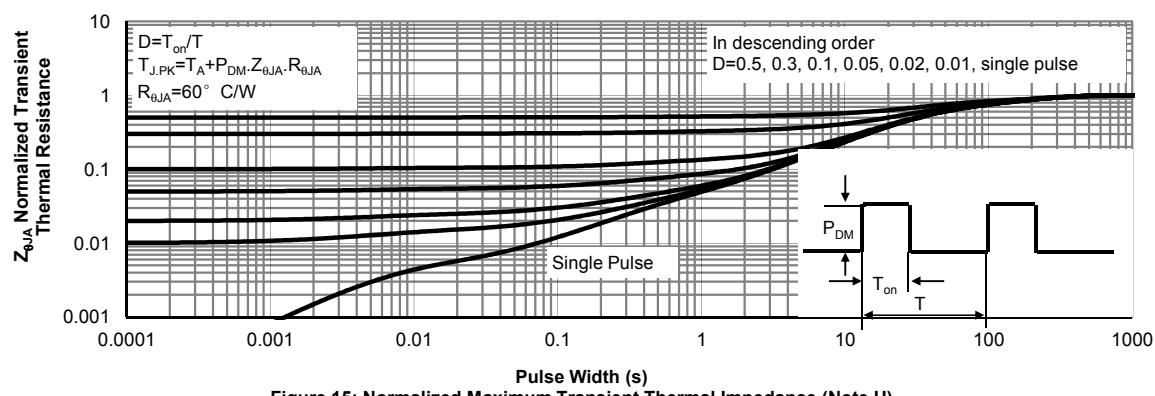
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 12: Power De-rating (Note F)

Figure 13: Current De-rating (Note F)

Figure 14: Single Pulse Power Rating Junction-to-Ambient (Note H)

Figure 15: Normalized Maximum Transient Thermal Impedance (Note H)

Figure A: Gate Charge Test Circuit & Waveforms

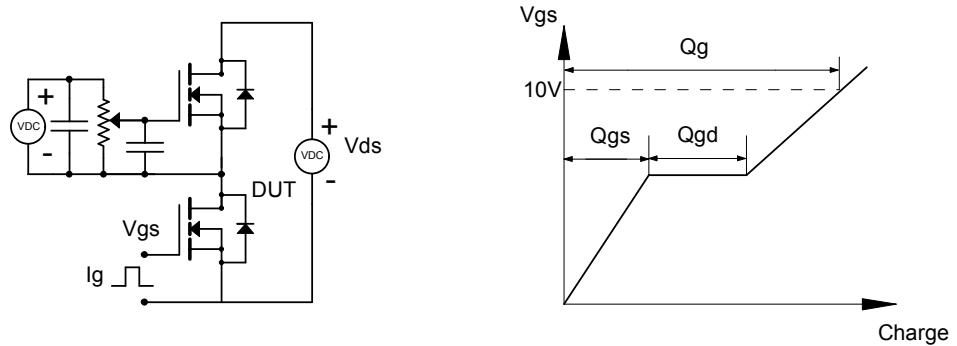


Figure B: Resistive Switching Test Circuit & Waveforms

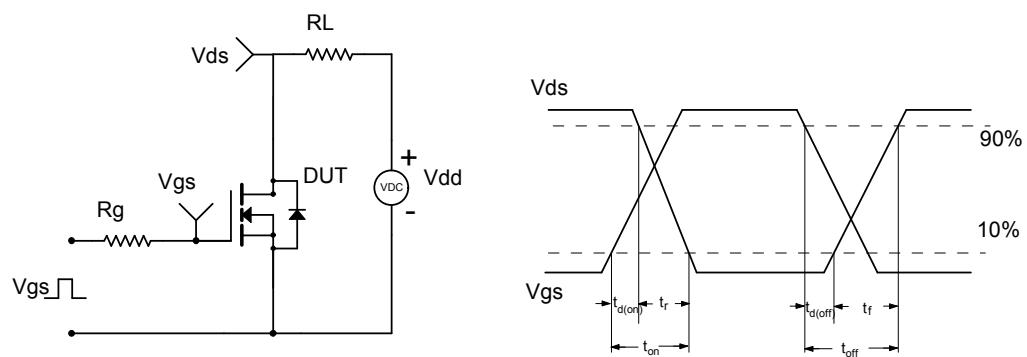


Figure C: Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

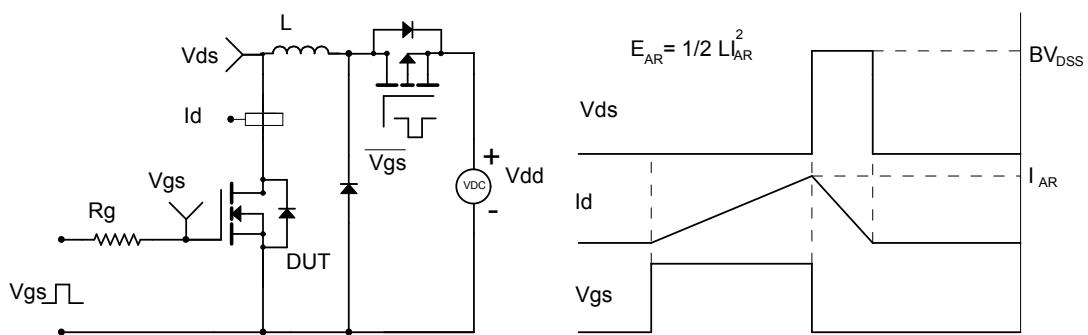
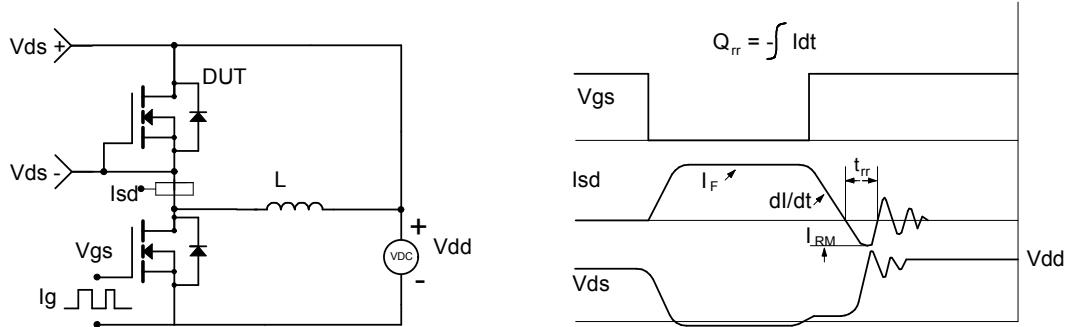


Figure D: Diode Recovery Test Circuit & Waveforms



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